EAST Search History

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|---|---|---|---|---|---|---|
| L1 | 5 | shozo with kadota. in. and inserting with lead near2 wire | US-PGPUB; USPAT; EPO; JPO | OR | ON | 2008/04/28 12:36 |
| L2 | 0 | kazuaki with kosaka.in. and inserting with lead near2 wire not 1 | US-PGPUB; USPAT; EPO; JPO | OR | ON | 2008/04/28 12:36 |
| L3 | 5 | shozo with kadota. in. and inserting with lead with wire | US-PGPUB; USPAT; EPO; JPO | OR | ON | 2008/04/28 12:36 |
| L4 | 0 | minoru with kitani. in. and inserting with lead near2 wire not L3 | US-PGPUB; USPAT; EPO; JPO | OR | ON | 2008/04/28 12:36 |
| L5 | 1 | ((lead wire pin leg) with (electronic electrical) near2 (part device element component) same (print$3 wiring circuit) near2 (board substrate) and (urg$4 grip$4 hold$3 grasp$4 press$4 push$3) with (pressure force magnitude) with (control$4 monitor$3 measur $3 detect$3) and (electronic electrical) near2 (part device element component) with (deformation deform$3 rigid$3 hardness)).clm. | US-PGPUB; USPAT; EPO; JPO | OR | ON | 2008/04/28 12:37 |

| L6 | 3 | ((lead wire pin leg) with (electronic electrical) near2 (part device element component) and (print$3 wiring circuit) near2 (board substrate) and (urg$4 grip$4 hold$3 grasp$4 press$4 push$3) with (pressure force magnitude) with (control$4 monitor$3 measur $3 detect$3) and (electronic electrical) near2 (part device element component) with (deformation deform$3 rigid$3 hardness)).clm. | US-PGPUB; USPAT; EPO; JPO | OR | ON | 2008/04/28 12:39 |
|---|---|---|---|---|---|---|
| S55 | 38 | ("3226833" \| "3261479" \| "3449008" \| "3509583" \| "3620095" \| "3770140" \| "3895729" \| "3904234" \| "3948093" \| "4001556" \| "4132318" \| "4423998" \| "4533167" \| "4546443" \| "4562551" \| "4566845" \| "4571694" \| "4579380" \| "4591944").PN. OR ("4680523"). URPN. | US-PGPUB; USPAT; USOCR | OR | ON | 2008/04/15 17:07 |

| S56 | 12 | ("3204997" \| "4593948" \| "4607873" \| "4680523" \| "5125708" \| "5190334" \| "5762391" \| "5967581" \| "6012222" \| "6334641").PN. OR ("6497440"). URPN. | US-PGPUB; USPAT; USOCR | OR | ON | 2008/04/15 17:13 |
|-----|----|------|------|----|----|------|
| S57 | 41 | ("3427520" \| "4579380" \| "4680523" \| "4699414" \| "4707013").PN. OR ("4808898"). URPN. | US-PGPUB; USPAT; USOCR | OR | ON | 2008/04/15 17:14 |
| S58 | 9 | ("3875481" \| "3921445" \| "3948093" \| "4132318").PN. OR ("4566845"). URPN. | US-PGPUB; USPAT; USOCR | OR | ON | 2008/04/15 17:16 |
| S59 | 19 | ("3168203" \| "3449008" \| "3759092" \| "4001556").PN. OR ("4533167"). URPN. | US-PGPUB; USPAT; USOCR | OR | ON | 2008/04/15 17:17 |
| S60 | 2 | (lead wire pin leg) with (electronic electrical) near2 (part device element component) same (print$3 wiring circuit) near2 (board substrate) and (urg$4 grip$4 hold$3 grasp$4 press$4 push$3) with (variable differen$3) near2 (pressure force magnitude) and (urg$4 grip$4 hold | USPAT; EPO; JPO | OR | ON | 2008/04/15 18:11 |

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|---|---|---|---|---|---|---|
| | | $3 grasp$4 press $4 push$3) with (control$4 monitor $3 measur$3 detect$3) and (electronic electrical) near2 (part device element component) with rigid$3 | | | | |
| S61 | 51 | (lead wire pin leg) with (electronic electrical) near2 (part device element component) same (print$3 wiring circuit) near2 (board substrate) and (urg$4 grip$4 hold$3 grasp$4 press$4 push$3) with (pressure force magnitude) and (urg$4 grip$4 hold$3 grasp$4 press$4 push$3) with (control$4 monitor$3 measur $3 detect$3) and (electronic electrical) near2 (part device element component) with rigid$3 not S60 | USPAT; EPO; JPO | OR | ON | 2008/04/15 18:13 |

| S62 | 13 | (lead wire pin leg) with (electronic electrical) near2 (part device element component) same (print$3 wiring circuit) near2 (board substrate) and (urg$4 grip$4 hold$3 grasp$4 press$4 push$3) with (pressure force magnitude) same (control$4 monitor$3 measur $3 detect$3) and (electronic electrical) near2 (part device element component) with rigid$3 not S60 not S61 | USPAT; EPO; JPO | OR | ON | 2008/04/15 18:28 |
|---|---|---|---|---|---|---|
| S63 | 26 | (lead wire pin leg) with (electronic electrical) near2 (part device element component) same (print$3 wiring circuit) near2 (board substrate) and (urg$4 grip$4 hold$3 grasp$4 press$4 push$3) with (pressure force magnitude) with (control$4 monitor$3 measur $3 detect$3) and (electronic electrical) near2 (part device element component) with (deformation deform$3 rigid$3 hardness) not S60 | USPAT; EPO; JPO | OR | ON | 2008/04/15 18:38 |

| | | not S61 not S62 | | | | |
|---|---|---|---|---|---|---|

4/28/08 12:40:04 PM
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\10521754 EC insertg lead wire.wsp